TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2843

Chopper Regulator, DC-DC Converter and Motor Drive Applications

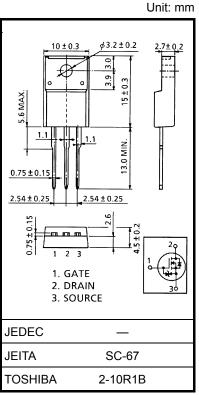
• Low drain-source ON resistance : $R_{DS (ON)} = 0.54 \Omega (typ.)$

High forward transfer admittance : |Y_{fs}| = 9.0 S (typ.)
 Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 600 V)

• Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	600	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	600	V
Gate-source voltage		V _{GSS}	±30	V
Drain current	DC (Note 1)	ID	10	Α
	Pulse (Note 1)	I _{DP}	40	Α
Drain power dissipatio	n (Tc = 25°C)	P _D	45	W
Single pulse avalanche	e energy (Note 2)	E _{AS}	363	mJ
Avalanche current		I _{AR}	10	Α
Repetitive avalanche	energy (Note 3)	E _{AR}	5.0	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature r	ange	T _{stg}	-55 to 150	°C



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 6.36 mH, R_{G} = 25 Ω , I_{AR} = 10 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

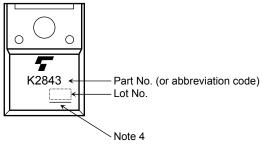
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cur	rent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600	_	_	V
Gate threshold v	roltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source OI	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A	_	0.54	0.75	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5 A	3.0	9.0	_	S
Input capacitano	e	C _{iss}		_	2040	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	230	_	pF
Output capacitance		Coss			590	_	
Switching time	Rise time	t _r	V_{GS} V_{OUT} V_{OUT} V_{OUT} V_{DD} V_{DD} V_{DD} V_{DD}	_	22	_	- ns
	Turn-on time	t _{on}		_	58	_	
	Fall time	t _f			36		
	Turn-off time	t _{off}			190	_	
Total gate charge (gate-source plus gate-drain)		Qg			45	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		25	_	nC
Gate-drain ("miller") Charge		Q _{gd}			20	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	10	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	40	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V		1300		ns
Reverse recovery charge	Q _{rr}	dl _{DR} / dt = 100 A / μs		16	1	μC

Marking

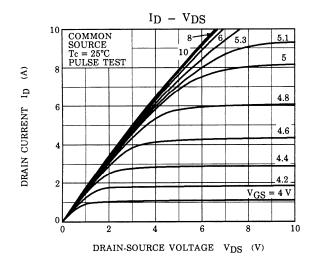


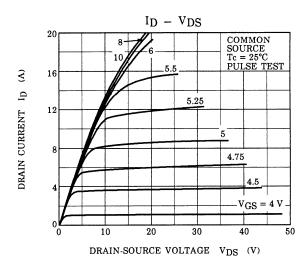
Note 4: A line under a Lot No. identifies the indication of product Labels.

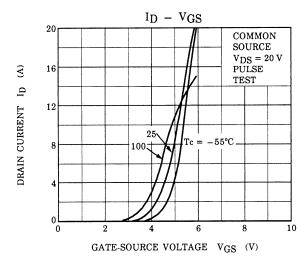
Not underlined: [[Pb]]/INCLUDES > MCV

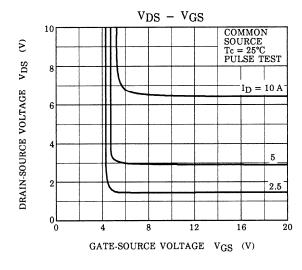
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

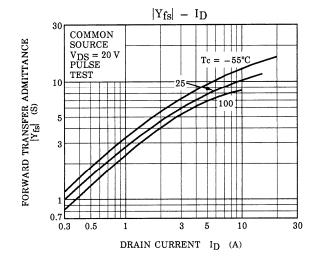
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

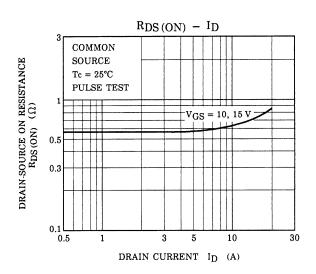




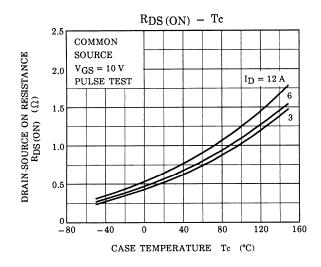


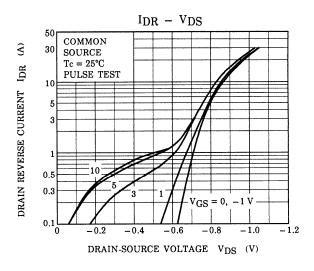


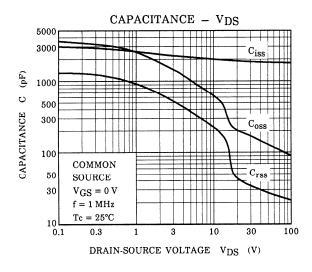


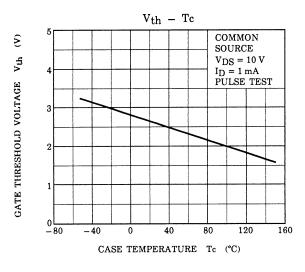


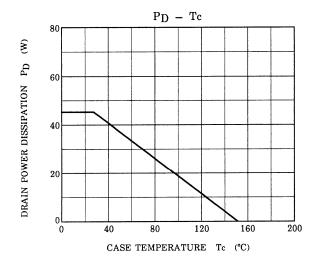
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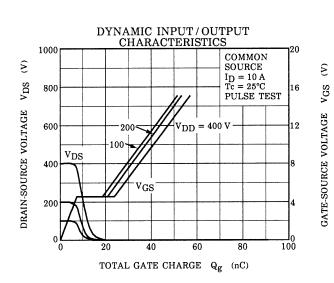


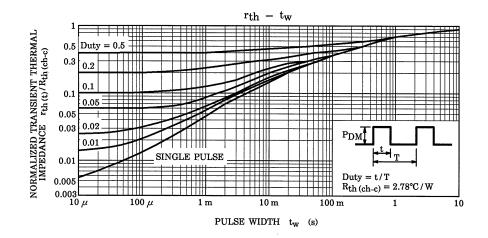


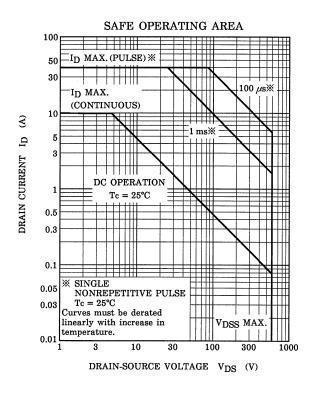


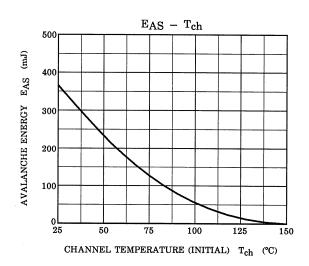


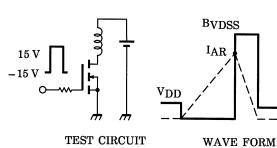












$$R_G$$
 = 25 Ω
 V_{DD} = 90 V, L = 6.36 mH

$$EAS = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

 v_{DS}

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